

# AMP DISPLAY INC.

### **SPECIFICATIONS**

CUSTOMER	
CUSTOMER PART NO.	
AMP PART NO	AM-480272H2TMQW-A0H!:
APPROVED BY	
DATE	

☑ Approved For Specifications

☐ Approved For Specifications & Sample

# **AMP DISPLAY INC**

9856 SIXTH STREET RANCHO CUCAMONGA CA 91730 TEL: 909-980-13410 FAX: 909-980-1419 WWW.AMPDISPLAY.COM

CHECKED BY	ORGANIZED BY
	CHECKED BY

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Date: 2010/07/27

# RECORD OF REVISION

Revision Date	Page	Contents	Editor
2010/8/27		New Release	Patrick
2012/4/23	4	Remove the Power Voltage	Leo

#### 1. FEATURES

(1) Construction: a-Si TFT-LCD with driving system, White LED Backlight.

(2) LCD type: Transmissive, Normally White

(3) Number of the Colors: 16.7M colors (R,G,B 8 bit digital each)

(4) RGB Interface 40 pin.

(5) LCD Power Supply Voltage: 3.3V single power input

(6) Interface mode: TTL RGB interface. Sync mode.

(7) Reflective ratio 0.5% ~ 2%

The timing control IC both supports DE mode and Sync mode timing. **The module default is Sync mode.** 

Mode	Hardware	PIN32:	PIN33:	PIN37:	Remark
Setting		HSYNC	VSYNC	NC(DE)	
Sync Mode	R8 NC	HSYNC	VSYNC	NC	Default
		needed	needed		DE pull low internally.
DE mode	R8= 0 ohm	HSYNC	VSYNC	DE	Option
		don't needed	don't needed	needed	In DE mode, only DE signal is needed. HSYNC and VSYNC pull High internally.

It is necessary to keep tvp+tvb=12 and thp+thb=43 in SYNC mode. DE mode is unnecessary. If you need the DE mode for mass production, please contact us to apply a part number for this option. (R8= 0 ohm).

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### 2. PHYSICAL SPECIFICATIONS

Item	Specifications	unit
Display size (diagonal)	4.3	inch
Resolution	480RGB (W) x 272(H)	dots
Display area	98.7 (W) x57.5 (H)	mm
Pixel pitch	0.198 (W) x 0.198 (H)	mm
Overall dimension	105.5(W)x114.05(H)x3.95(D)	mm
Color configuration	R.G.B Vertical stripe	
View Direction (Gray Inversion)	6 o'clock	

### 3. ABSOLUTE MAXIMUM RATINGS

item	Symbol	Val	ues	Unit	Remark
Ttom	Min Max		Oilit	Kemark	
Power Supply for logic	VCC	-0.3	5.0	V	GND=0
Operation Temperature (Ambient)	Тор	-20	70	$^{\circ}\!\mathbb{C}$	
Storage Temperature (Ambient)	Тѕт	-30	80	$^{\circ}\!\mathbb{C}$	Note 1
LED Forward current	lf		20	mA	OneLED/Note2
LED Power Dissipation	Pd		64	mW	One LED

<sup>\*</sup>TFT LCD Ratings

Note 1: Hsync, Vsync, DEN, DCLK, R0~R7, G0~G7, B0~B7

Note 2: Background color changes slightly depending on ambient temperature. This phenomenon is reversible.

### 4. OPTICAL CHARACTERISTICS

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Response	Time	T <sub>r</sub> +T <sub>f</sub>	$T_r + T_f$		40		ms	(3)
Contrast r	atio	CR Θ=Φ=0°			250	-	-	(1)
Viewing	Vertical	Θ	CR≧10		90.	-	Dog	(4)
Angle	Horizontal	Ф	UR≦ IU		130	-	Deg.	(4)
Luminance		L	Θ=Φ=0°		500		cd/m²	(2)
Color White		Wx			0.301			(2)(3)
chromatic	ity	Wy			0.339			(2)(3)

NOTE:

Measure Condition:IL= 20.0mA
Measure Item Definition as follow:

(1)Definition of Contrast Ratio: (Measured by BM-7 (TOPCON) [dark room])
Contrast Ratio (CR)= (White) Luminance of ON ÷ (Black) Luminance of OFF

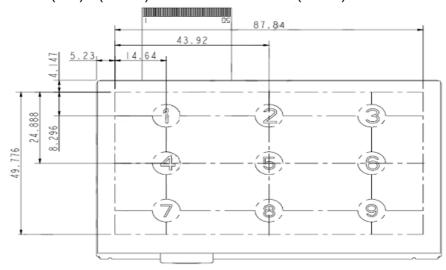


Fig.9-1: Test Point Position

(2) Definition of Center Luminance &Luminance Uniformity: (Measured by BM-7 (TOPCON) [dark room])

Center Luminance: Measure luminance on Point No5 as figure 9-1.

Luminance Uniformity: Measure maximum luminance(L(MAX)) and minimum luminance (L(MIN)) on the **9** points as figure 9-1.

 $L = [L(MIN)/L(MAX)] \times 100\% \triangle$ 

(3) Response Time (White - Black)

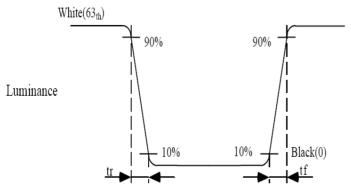
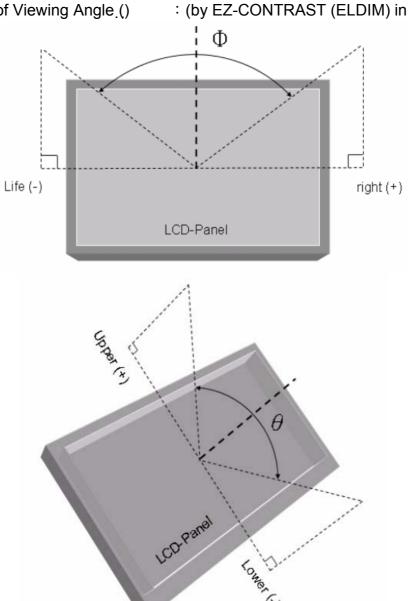


Fig.9-2: Definition of Response Time (White - Black)

: (by EZ-CONTRAST (ELDIM) in the dark room. ) (4)Definition of Viewing Angle ()



### 5. ELECTRICAL CHARACTERISTICS

### **LCD** driving

Item		Symbol	Min.	Тур.	Max.	Unit	Note
Power supply voltage		VDD	3.0	3.3	3.6	<b>V</b>	
Input voltage for	tage for H Level		0.8 VDD		VDD	V	(1)
logic	L Level	$V_{IL}$	0		0.2 VDD	V	(1)
Power Supply current		IDD		45		mA	(2)

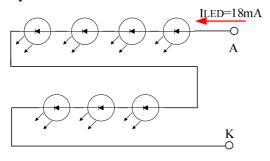
Note 1: Hsync, Vsync, DEN, DCLK, R0~R5, G0~G5, B0~B5

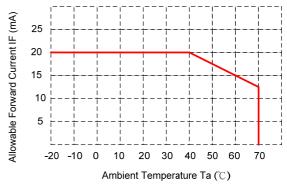
Note 2: fV =60Hz , Ta=25°C , Display pattern : All Black

LED back light specification

Item	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage	$V_{f}$	I <sub>f</sub> =18mA		23.1	25.2	V
Forward current	I <sub>f</sub>	7-chip serial	-	18	20	mA
Uniformity (with L/G)	-	I <sub>f</sub> =18mA	75%*1	-	-	
Life Time		Ta=25°C, I <sub>F</sub> =20mA	17.7K			Hrs
(LED Dice)	-	IF=20mA	17.7K			піѕ
Luminous color	White					
Chip connection		7 ch	nip serial c	onnection		

■ The constant current source is needed for white LED back-light driving. When LCM is operated over 60 deg.C ambient temperature, the I<sub>LED</sub> of the LED back-light should be adjusted to 15mA max

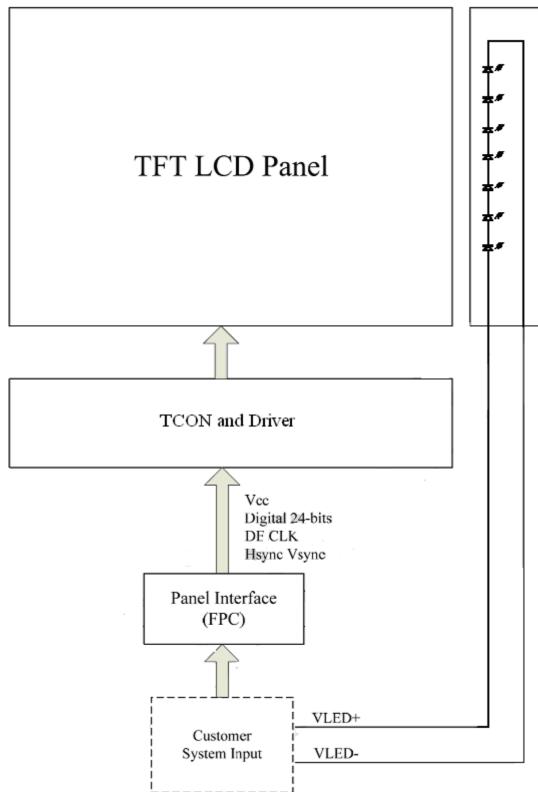




Pin definition of Backlight

Pin no	Symbol	Function
1	LED_K	LED Cathode
2	NC	Keep NC
3	NC	Keep NC
4	LED_A	LED Anode

### 6. BLOCK DIAGRAM



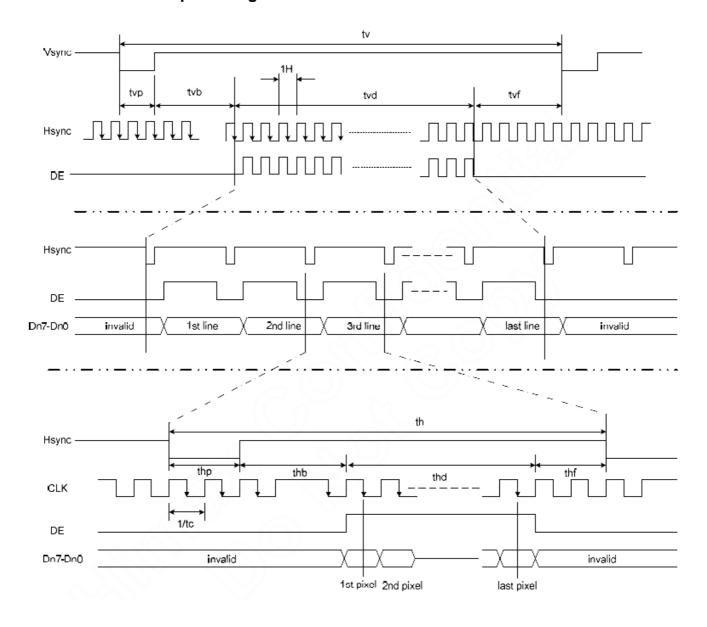
# 7. TFT LCD Panel FPC Descriptions

Pin no	Symbol	Function	Remark
1	GND	Ground	
2	GND	Ground	
3	VCC	Power Supply(3.3V)	
4	VCC	Power Supply(3.3V)	
5	R0	Red Data Bit 0	
6	R1	Red Data Bit 1	
7	R2	Red Data Bit 2	
8	R3	Red Data Bit 3	
9	R4	Red Data Bit 4	
10	R5	Red Data Bit 5	
11	R6	Red Data Bit 6	
12	R7	Red Data Bit 7	
13	G0	Green Data Bit 0	
14	G1	Green Data Bit 1	
15	G2	Green Data Bit 2	
16	G3	Green Data Bit 3	
17	G4	Green Data Bit 4	
18	G5	Green Data Bit 5	
19	G6	Green Data Bit 6	
20	G7	Green Data Bit 7	
21	B0	Blue Data Bit 0	
22	B1	Blue Data Bit 1	
23	B2	Blue Data Bit 2	
24	B3	Blue Data Bit 3	
25	B4	Blue Data Bit 4	
26	B5	Blue Data Bit 5	
27	B6	Blue Data Bit 6	
28	B7	Blue Data Bit 7	
29	GND	Ground	
30	DCLK	Dot Data Clock	
31	DISP	Display ONOFF	
32	Hsync	SYNC mode: Horizontal Sync Input	(Note1)
02	1103110	DE mode: no function. Can be floating.	(110101)
33	Vsync	SYNC mode: Vertical Sync Input	(Note1)
		DE mode: no function. Can be floating.	(110101)
34	NC	Not Connection	
35	NC	Not Connection	
36	NC	Not Connection	
37	NC (DE)	SYNC mode: Not Connection	(Note1)
		DE mode: DE signal input	(
38	Test1	Not Connection	
39	Test2	Not Connection	
40	Test3	Not Connection	VE made if D0 is (

(Note1): The module is SYNC mode, if R8 is open. The module is DE mode, if R8 is 0 ohm.

### 8. INPUT SIGNAL

## 8.1 Parallel RGB input timing Chart



#### 8.2 Timing Specification

Parallel RGB input timing requirement

PARAMETER	Symbol	Min.	Тур.	Max.	Unit
Clock cycle	1/t <sub>c*1</sub>		9	15	MHz
Hsync cycle	1/f <sub>н</sub>		17.14	-	KHz
Vsync cycle	1/f <sub>∨</sub>		59.94	-	Hz
	Horizonta	al Signal			
Horizontal cycle	th*2	525	525	605	CLK
Horizontal display period	thd	480	480	480	CLK
Horizontal front porch	thf	2	2	82	CLK
Horizontal pulse width	thp	2	41	41	CLK
Horizontal back porch	thb	2	2	41	CLK
	Vertical	Signal			
Vertical cycle	tv	285	286	399	Н
Vertical display period	tvd	272	272	272	Н
Vertical front porch	tvf	1	2	227	Ι
Vertical pulse width	tvp	1	10	11	Н
Vertical back porch	tvb	1	2	11	Н

#### Note:

- Unit: CLK=1/ fCLK , H=th
   Parallel interface. Clock frequency and horizontal signal parameters are tripled in serial interface. The Maximum clock frequency of serial interface is 33MHz
- 3. It is necessary to keep tvp+tvb=12 and thp+thb=43 in SYNC mode. DE mode is unnecessary.

### 8.3 Timing Chart 2

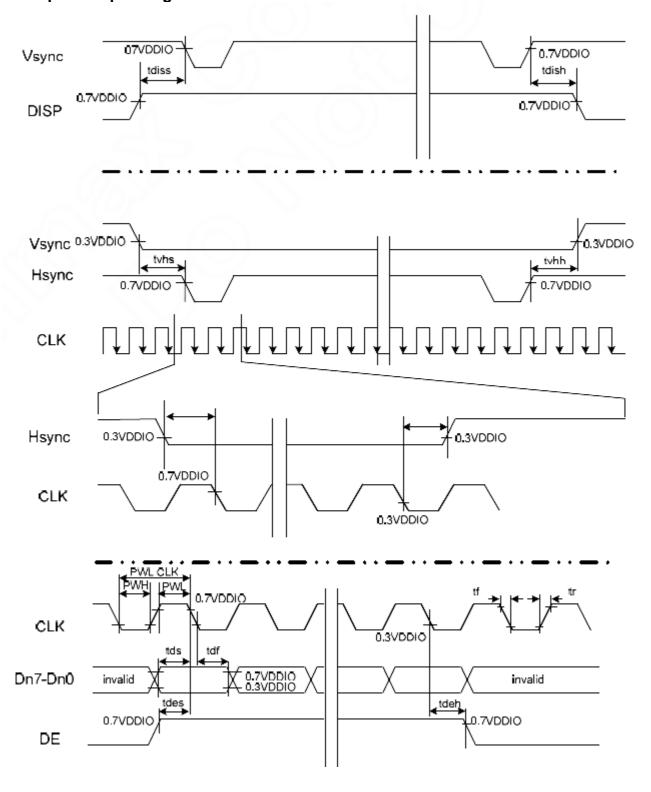
Input setup timing requirement

PARAMETER	Symbo	Min.	Тур.	Max.	Unit
	I				
DISP setup time	<b>t</b> diss	10	-	-	ns
DISP hold time	<b>t</b> dish	10	-		ns
Clock period	PW <sub>CLK</sub> *1	66.7	-	-	ns
Clock pulse high period	PWH <sup>™</sup>	26.7	-	-	ns
Clock pulse low period	PWL*1	26.7	-	-	ns
Hsync setup time	t <sub>hs</sub>	10	-	-	ns
Hsync hold time	t <sub>hh</sub>	10	-		ns
Data setup time	t <sub>ds</sub>	10	-	-	ns
Data hold time	$t_{\scriptscriptstyledh}$	10	-	-	ns
DE setup time	t <sub>des</sub>	10	-	-	ns
DE hold time	t <sub>deh</sub>	10	-	-	ns
Vsync setup time	t <sub>vhs</sub>	10	-	-	ns
Vsync hold time	$t_{\scriptscriptstylevhh}$	10	-	-	ns

#### Note

- 1. For parallel interface, maximum clock frequency is 15MHz.
- 2. tr, tf is defined 10% to 90% of signal amplitude.

### 8.4 Input setup timing Chart



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9. Color Data Assignment

COLOR	INPUT	Assignment							G DATA								B DATA								
COLOR		R DATA R7 R6 R5 R4 R3 R2 R1 R0													B DATA B7 B6 B5 B4 B3 B2 B1 B0										
	DATA			Кō	К4	R3	R2		į			G5	G4	G3	G2					Вō	В4	B3	B2		
		MSB		_	_	^	_	=	_	MSB	=	_	^	^			_	MSB		^	_	^	_	=	LSB
1	BLACK	0				0			0	0		0		0	0		0	0	0			0		0	0
1 1	RED(255)	1				1				0	0	0	0	0	0	0	0	0	0	0				0	0
1 1	GREEN(255)	0		0		0		0	0	1 	1	1 	1	1	1	1	1	0		0	0	0	0	0	0
	BLUE(255)	0			0				0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
1	CYAN	0			0					1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
1	MAGENTA	1	1	1	1	1		1	1	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1
1 1	YELLOW	1	1	1	1	1		1	1	1	1	1	1	1	1	1	1	0	0	0	0			0	0
	WHITE	1	1	1	-	1	_	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1		1	_
1	RED(0)	0	0	0				0	0	0	0	0			0		0	0	0			0	ļ	0	
1 1	RED(1)	0		0			******	*********	1	0						0	0	0		0		Ü		0	
	RED(2)	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RED																									
	RED(254)	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	()	0	0	0	0	0	0	0	0
	RED(255)	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(0)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	GREEN(1)	0	0	0	0	0	0	0	0	0	0	0	0	9	0	0	1	- 0	0	0	0	0	0	0	0
	GREEN(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
GREEN												, 1													
	GREEN(254)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0
	GREEN(255)	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0
	BLUE(0)	0	0	0	0	0	0	0	0	0	0	0.	0	0	0	0	0	0	0	0	0	0	0	0	0
	BLUE(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	BLUE(2)	0	0	0	0	0	í)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
BLUE						- "																			
	BLUE(254)	0	0	9	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	0
I I	BLUE(255)	0		0			irmani	in the same		0		0						1	1	1	i				1

#### 10. QUALITY AND RELIABILITY

#### **10.1Test Conditions**

Tests should be conducted under the following conditions:

Ambient temperature :  $25 \pm 5^{\circ}$ C Humidity :  $60 \pm 25\%$  RH.

#### 10.2 Sampling Plan

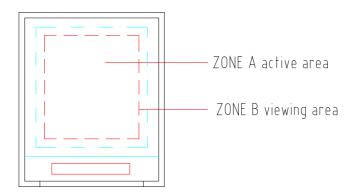
Sampling method shall be in accordance with MIL-STD-105E, level II, normal single sampling plan.

#### 10.3 Acceptable Quality Level

A major defect is defined as one that could cause failure to or materially reduce the usability of the unit for its intended purpose. A minor defect is one that does not materially reduce the usability of the unit for its intended purpose or is an infringement from established standards and has no significant bearing on its effective use or operation.

#### 10.4 Appearance

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under florescent light. The inspection area of LCD panel shall be within the range of following limits.

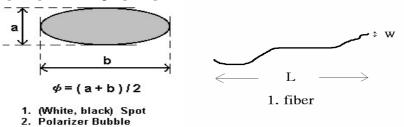


# 11. Incoming Inspection Standard

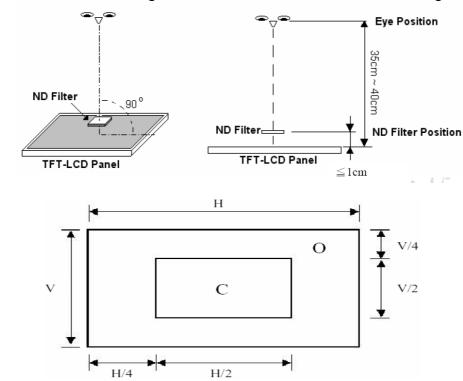
No.	Item	Criterion	for defects	Class of Defect	Accept able level
1	Non display	No non display is allowed		Major	0.4
2	Irregular operation	No irregular operation is all	owed	Major	0.4
3	Short	No short are allowed		Major	0.4
4	Open	Any segments or common are rejectable.	n patterns that don't activate	Major	0.4
5	Black/White spot (I)	Size D (mm) $D \le 0.1$ $0.1 < D \le 0.3$ $0.3 < D$ $1: The distance of two defects$	Acceptable number Ignore 4 %1 0 s must be more than 20mm.	Minor	1.5
6	Dot Defect	Bright dot  Dark dot  Total dot defect (Bright dot + Dark dot)  Minimum distance betweed dark dot and dark dot	$N \le 2$ $N \le 4$ $N \le 6$ $L \ge 5 mm$	Minor	1.5
7	Back Light	No Lighting is rejectable     Flickering and abnormal		Major	0.4
8	Display pattern	$\frac{A+B}{2} \le 0.30  0 < C$ Note: 1. Acceptable up to 3 da	nit:mm $\frac{D+E}{2} \le 0.25  \frac{F+G}{2} \le 0.25$	Minor	1.5
9	Blemish & Foreign matters  Size: $D = \frac{A+B}{2}$	Size D (mm)  D ≤ 0.15  0.15 < D ≤ 0.20  0.20 < D ≤ 0.30  0.30 < D	Acceptable number Ignore 3 2 0	Minor	1.5

10	Scratch on Polarizer	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	Minor	1.5
11	Bubble in polarizer	$D\!\leqq 0.15$ mm, Ignored $0.15 \leqq D \leqq 0.5$ mm, N $\leqq 4$ D $> 0.5$ mm, not allowable D= (A+B) / 2	Minor	1.5
12	Stains on LCD panel surface	Stains that cannot be removed even when wiped lightly with a soft cloth or similar cleaning too are rejectable.	Minor	1.5
13	Rust in Bezel	Rust which is visible in the bezel is rejectable.	Minor	1.5
14	Defect of land surface contact (poor soldering)	Evident crevices which is visible are rejectable.	Minor	1.5
15	Parts mounting	Failure to mount parts     Parts not in the specifications are mounted     Polarity, for example, is reversed	Major Major Major	0.4
16	Parts alignment	<ol> <li>LSI, IC lead width is more than 50% beyond pad outline.</li> <li>Chip component is off center and more than 50% of the leads is off the pad outline.</li> </ol>	Minor Minor	1.5
17	Conductive foreign matter (Solder ball, Solder chips)	<ul> <li>1. 0.45&lt;φ ,N≥1</li> <li>2. 0.30&lt;φ≤0.45 ,N≥1</li> <li>φ:Average diameter of solder ball (unit: mm)</li> <li>3. 0.50<l ,n≥1<="" li=""> <li>L: Average length of solder chip (unit: mm)</li> </l></li></ul>	Major Minor Minor	0.4 1.5 1.5
18	Faulty PCB correction	<ol> <li>Due to PCB copper foil pattern burnout, the pattern is connected, using a jumper wire for repair; 2 or more places are corrected per PCB.</li> <li>Short circuited part is cut, and no resist coating has been performed.</li> </ol>	Minor Minor	1.5
19	mura	ND 6% , See, not allowable	Minor	

[Note1] W: Width[mm], L: Length[mm], N: Number, φ: Average Diameter



[Note2] Bright dot is defined through 6% transmission ND Filter as following.

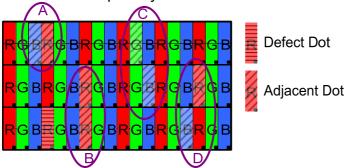


C Area: Center of display area C Area: Outer of display area

#### [Note4]

[Note3]

Judge defect dot and adjacent dot as following. Allow below (as A, B, C and D status) adjacent defect dots, including bright and dart adjacent dot. And they will be counted 2 defect dots in total quantity.



- (1) The defects that are not defined above and considered to be problem shall be reviewed and discussed by both parties.
- (2) Defects on the Black Matrix, out of Display area, are not considered as a defect or counted.

#### 12. Reliability Test

Test Item	Test Conditions	Note						
High Temperature Operation	70±3°C , t=96 hrs							
Low Temperature Operation	-20±3°C , t=96 hrs							
High Temperature Storage	80±3°C , t=96 hrs	1,2						
Low Temperature Storage	-30±3°C , t=96 hrs	1,2						
Thermal Shock Test	-30°C ~ 25°C ~ 80°C 30 m in. 5 min. 30 min. (1 cycle ) Total 5 cycle	1,2						
Humidity Test	40 °C, Humidity 90%, 96 hrs	1,2						
	Sweep frequency: 10 ~ 55 ~ 10 Hz/1min Amplitude: 0.75mm Test direction: X.Y.Z/3 axis Duration: 30min/each axis	2						

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions (15-35°C , 45-65%RH).

### Definitions of life end point :

- Current drain should be smaller than the specific value.
- Function of the module should be maintained.
- Appearance and display quality should not have degraded noticeably.
- Contrast ratio should be greater than 50% of the initial value.

#### 13. USE PRECAUTIONS

#### 13.1 Handling precautions

- 1) The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.
- 2) Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzene and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.
- 3) Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.
- 4) If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

#### 13.2 Installing precautions

- 1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx.  $1M\Omega$  and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
- 2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
- 3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
- 4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

#### 13.3 Storage precautions

- 1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
- 2) Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.
- 3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

#### 13.4 Operating precautions

- 1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
- 2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
- 3) The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
- 4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
- 5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
- 6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.
- 7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.
- 8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

#### 13.5 Other

- 1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
- 2) The residual image may exist if the same display pattern is shown for hours. This residual image, however, disappears when another display pattern is shown or the drive is interrupted and left for a while. But this is not a problem on reliability.
- 3) AMIPRE will provide one year warrantee for all products and three months warrantee for all repairing products.

#### 14 OUTLINE DIMENSION

